



IN THE  
UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION  
OF:

Toshihide ITO, et al.

200335-0037

CASE:

09/671,084

SERIAL NO.:

September 27, 2000

FILED ON:

FOR:

Sn-Ag-Cu SOLDER AND SURFACE  
TREATMENT AND PARTS MOUNTING  
METHODS USING THE SAME

) EXPRESS MAIL  
) CERTIFICATE OF  
) MAILING FOR:  
) RCE Application

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Dear Sirs:

- [X] AUTHORIZATION TO PAY AND PETITION FOR THE ACCEPTANCE OF ANY NECESSARY FEES: If any charges or fees must be paid in connection with the following Communication (including but not limited to the payment of issue fees), they may be paid out of our deposit account No. 50-1965. If this payment also requires a Petition, please construe this authorization to pay as the necessary Petition which is required to accompany the payment.

**INFORMATION DISCLOSURE STATEMENT**

Applicant submits herewith a list of prior art (PTO form 1449) which should be placed of record in the above identified application.

It is believed that the present invention clearly distinguishes over the enclosed prior art.

Dated: 9/9/02

By: [Signature]

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Date of Deposit: August 9, 2002

I hereby certify that the above listed papers or fees are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above, addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231. The person mailing these papers/fees is:

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